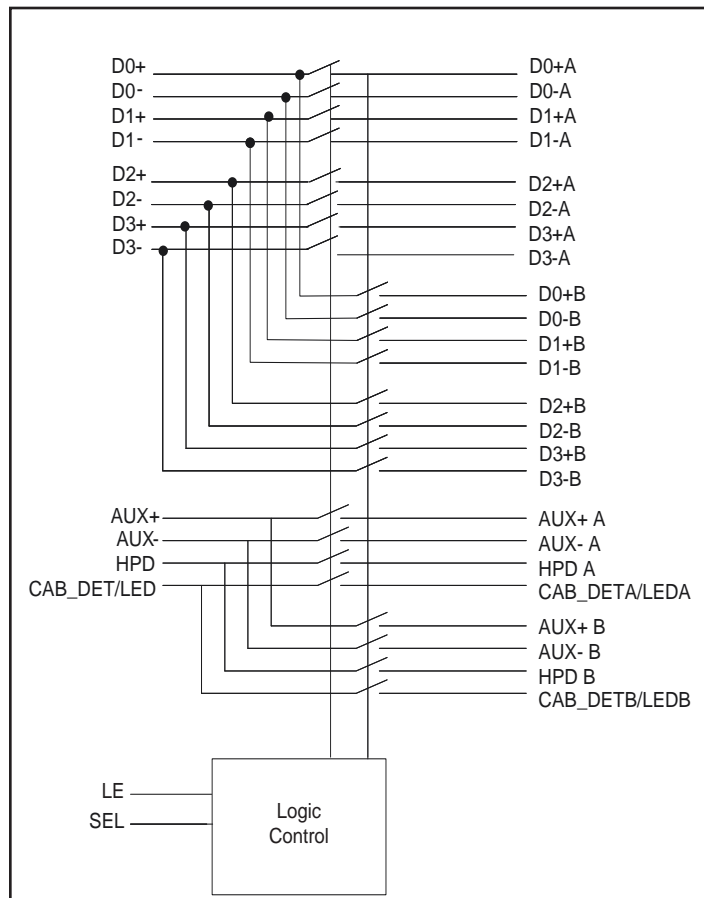


High Bandwidth 6-differential Channel, 1:2 Demux for DisplayPort™ rev 1.1a Signal Switching

Features

- 4 Differential Channel, 1:2 DeMux that will support 2.7Gbps DP rev 1.1a signals
- 1-channel 1:2 demux for DP_HPDP signal
- 1-differential channel 1:2 demux for DP_Aux signal
- Insertion Loss for high speed channels @ 2.7 Gbps: -1.5dB
- Hot Insertion Cable
- -3dB Bandwidth for high speed channels of 3.25 Ghz
- Low Bit-to-Bit Skew , 7ps max (between '+' and '-' bits)
- Low Crosstalk for high speed channels: -33dB@2.7 Gbps
- Low Off Isolation for high speed channels: -26dB@2.7 Gbps
- V_{DD} Operating Range: 3.3V +/-10%
- ESD Tolerance: 8kV contact on all data I/O pins per IEC61000-4-2 Specification
- Low channel-to-channel skew, 35ps max
- Packaging (Pb-free & Green):
 - 56 TQFN (ZFE)
 - 42 TQFN (ZHE)

Block Diagram



Description

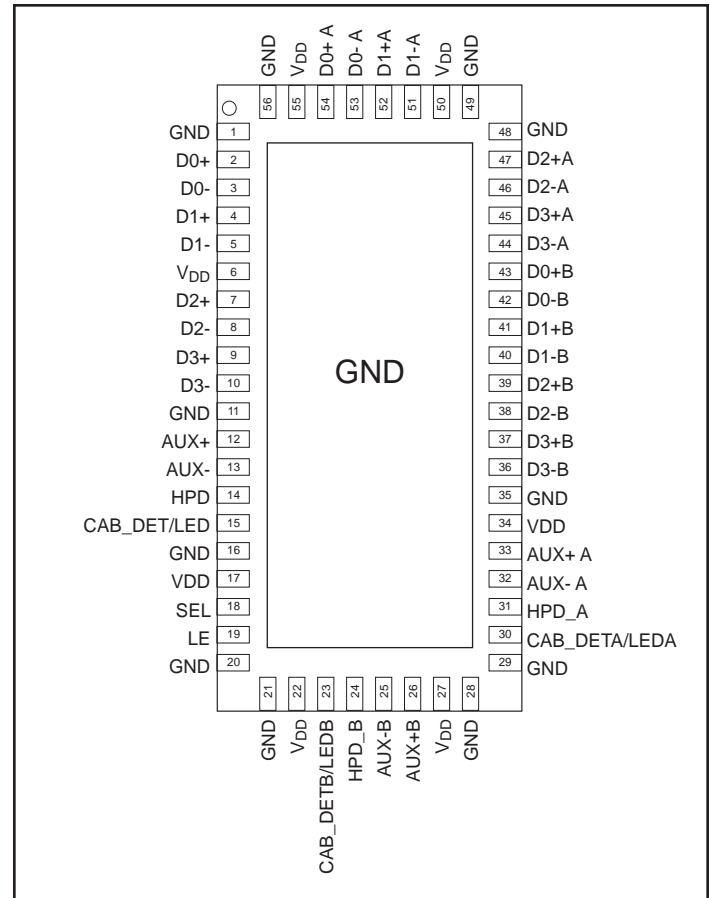
Pericom Semiconductor's PI3VDP612, one to two Demux is targeted for next generation digital video signals. This device can be used to connect a Display Port Source to two Independent Display Port Sinks.

The newly released Display Port spec requires a data rate of 2.7 Gbps with AC coupled I/Os. Pericom's solution has been specifically designed around this standard and will support such signals.

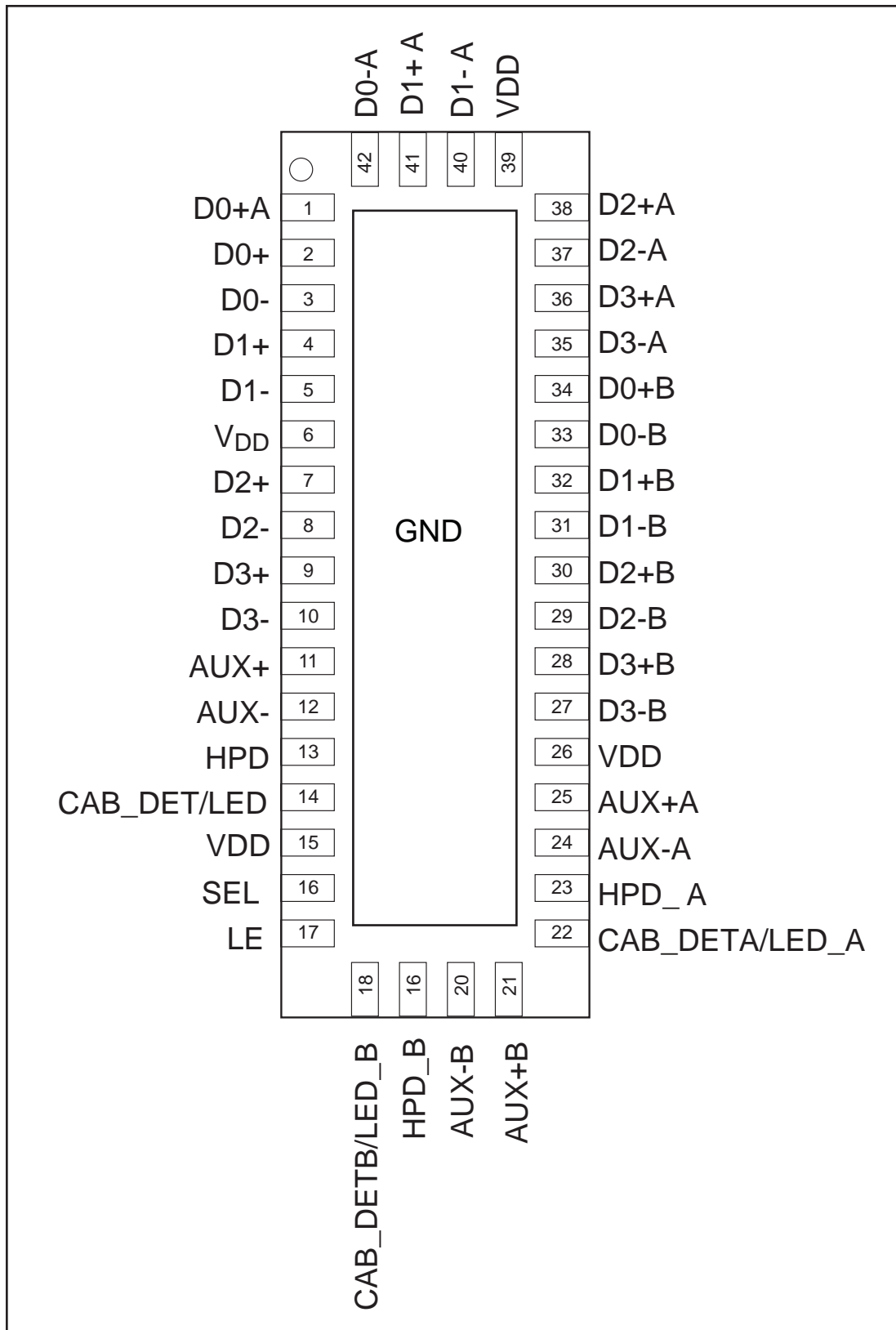
Application

Routing of Display Port signals with low signal attenuation between notebook DP connector and docking station DP connector.

Pin Description - 56-Pin



Pin Description- 42-Pin



Pin Description

42-Package Pin #	56-Package Pin #	Pin Name	Signal Type	Description
	1	GND	Power	Ground
2	2	D0+	I/O	Positive Lane0 signal for common port
3	3	D0-	I/O	Negative Lane0 signal for common port
4	4	D1+	I/O	Positive Lane1 signal for common port
5	5	D1-	I/O	Negative Lane1 signal for common port
6	6	VDD	Power	3.3V Power Supply
7	7	D2+	I/O	Positive Lane2 signal for common port
8	8	D2-	I/O	Negative Lane2 signal for common port
9	9	D3+	I/O	Positive Lane3 signal for common port
10	10	D3-	I/O	Negative Lane3 signal for common port
	11	GND	Power	Ground
11	12	AUX+	I/O	Positive AUX signal for common port
12	13	AUX-	I/O	Negative AUX signal for common port
13	14	HPD	I/O	HPD for common port
14	15	CAB_DET/LED	I/O	common port pin13 from dual mode DP connector or LED common port
	16	GND	Power	Ground
15	17	VDD	Power	3.3V Power Supply
16	18	SEL	Input	Port Selection Control. If LOW, then port A is active. If HIGH, then port B is active
17	19	LE	Input	Latch Control. If LOW, then SEL pin will control port selection. If HIGH, then controllability is Latched.
	20	GND	Power	Ground
	21	GND	Power	Ground
	22	VDD	Power	3.3V Power Supply
18	23	CAB_DET/LEDB	I/O	PortB pin13 from dual mode DP connector or LED from port B
19	24	HPD_B	I/O	HPD for port B
20	25	AUX-B	I/O	Negative AUX signal for Port B
21	26	AUX+B	I/O	Positive AUX signal for Port B
	27	VDD	Power	3.3V Power Supply
	28	GND	Power	Ground
	29	GND	Power	Ground
22	30	CAB_DET/LEDA	I/O	PortA pin13 from dual mode DP connector or LED from port A
23	31	HPD_A	I/O	HPD for port A
24	32	AUX-A	I/O	Negative AUX signal for Port A
25	33	AUX+A	I/O	Positive AUX signal for Port A

(Continued)

42-Package Pin #	56 Package Pin #	Pin Name	Signal Type	Description
26	34	VDD	Power	3.3V Power Supply
	35	GND	Power	Ground
27	36	D3-B	I/O	Negative Lane3 signal for Port B
28	37	D3+B	I/O	Positive Lane3 signal for Port B
29	38	D2-B	I/O	Negative Lane2 signal for Port B
30	39	D2+B	I/O	Positive Lane2 signal for Port B
31	40	D1-B	I/O	Negative Lane1 signal for Port B
32	41	D1+B	I/O	Positive Lane1 signal for Port B
33	42	D0-B	I/O	Negative Lane0 signal for Port B
34	43	D0+B	I/O	Positive Lane0 signal for Port B
35	44	D3-A	I/O	Negative Lane3 signal for Port A
36	45	D3+A	I/O	Positive Lane3 signal for Port A
37	46	D2-A	I/O	Negative Lane2 signal for Port A
38	47	D2+A	I/O	Positive Lane2 signal for Port A
	48	GND	Power	Ground
	49	GND	Power	Ground
39	50	VDD	Power	3.3V Power Supply
40	51	D1-A	I/O	Negative Lane1 signal for Port A
41	52	D1+A	I/O	Positive Lane1 signal for Port A
42	53	D0-A	I/O	Negative Lane0 signal for Port A
1	54	D0+A	I/O	Positive Lane0 signal for Port B
	55	VDD	Power	3.3V Power Supply
	56	GND	Power	Ground

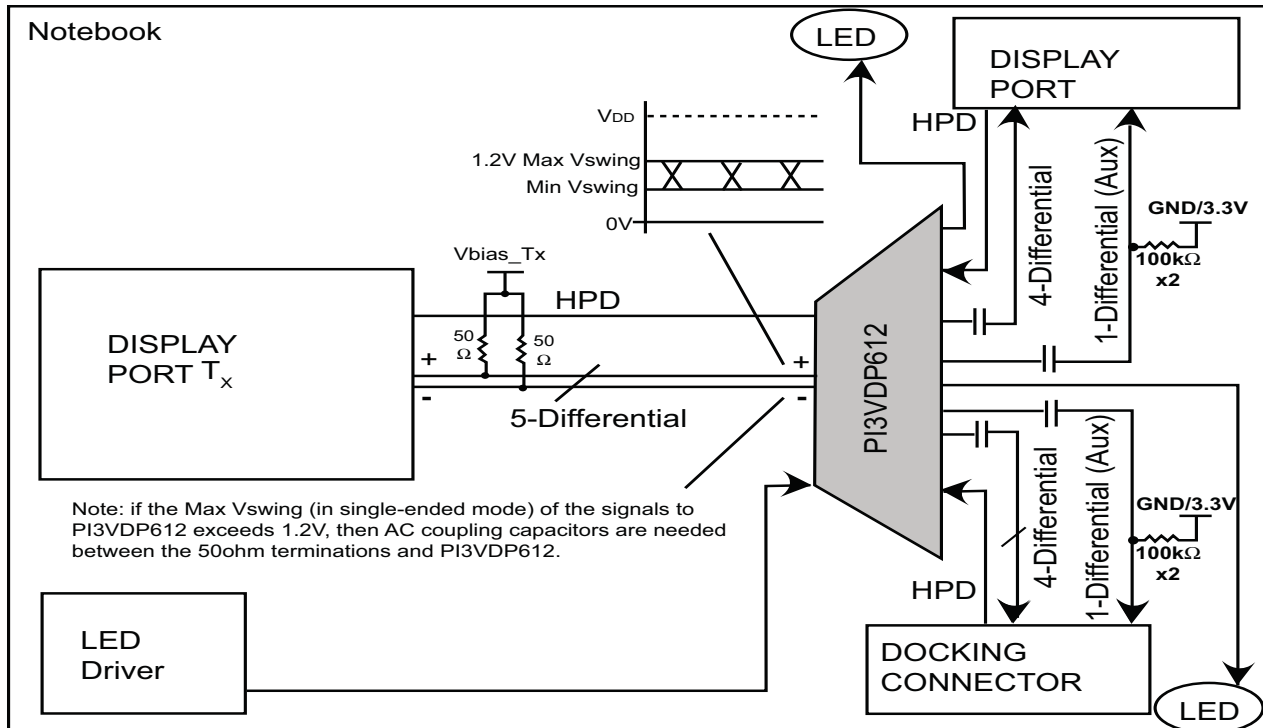
Truth Table (SEL control)

Function	SEL
Port A is active	L
Port B is active	H

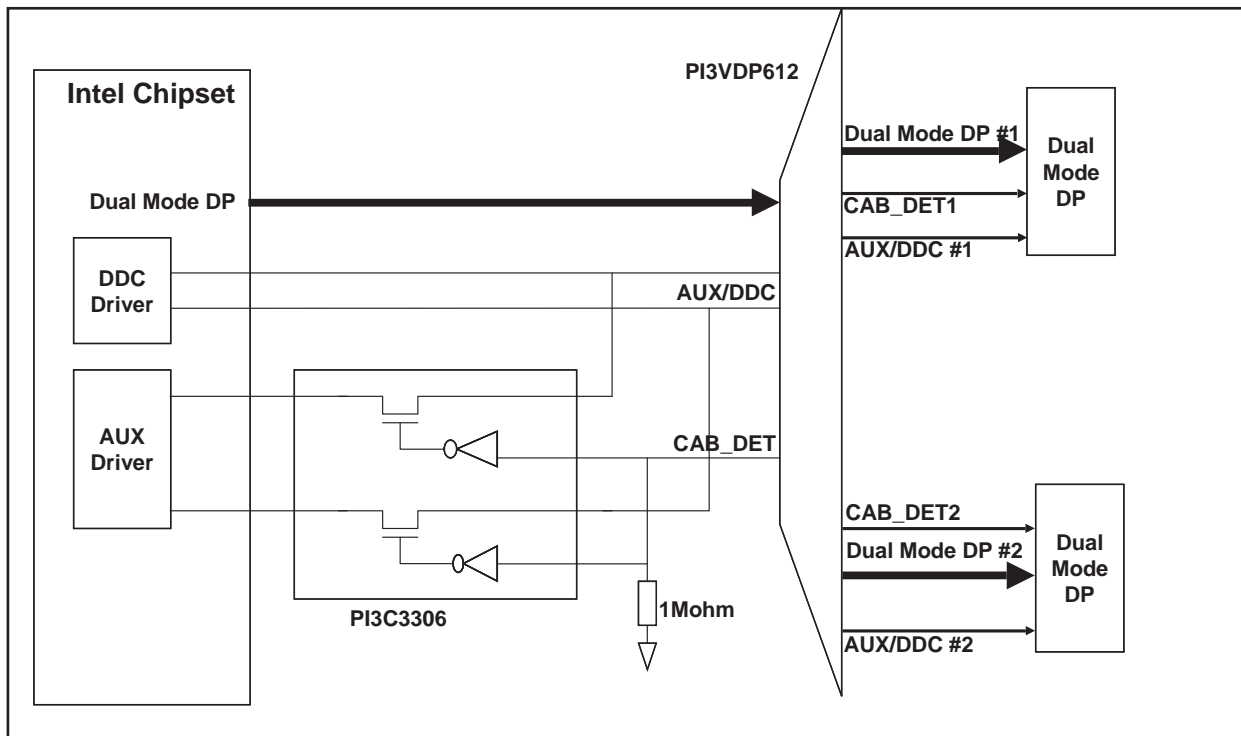
Truth Table (Latch control)

LE	SEL
0	Responds to changes on SEL
1	Latched

Application Example for single mode DP support



Application Example for Dual Mode Display Port Support



Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Supply Voltage to Ground Potential	-0.5V to +3.6V
DC Input Voltage	-0.7V to 3.6V
DC Output Current	120mA
Power Dissipation	0.5W

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics for Switching over Operating Range (T_A = -40°C to +85°C, V_{DD} = 3.3V +/-10%)

Parameter	Description	Test Conditions ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units
V _{IH}	Input HIGH Voltage	Guaranteed HIGH level	1.6			V
V _{IL}	Input LOW Voltage	Guaranteed LOW level			0.75	
V _{IK}	Clamp Diode Voltage	V _{DD} = Max., I _{IN} = -18mA		-0.7	-1.2	
I _{IH}	Input HIGH Current	V _{DD} = Max., V _{IN} = V _{DD}			±5	µA
I _{IL}	Input LOW Current	V _{DD} = Max., V _{IN} = GND			±5	
R _{ON}	On resistance between input to output	V _{DD} = 3.0V, -0.6V < V _{INPUT} < 0.6V			7	Ohm
		V _{DD} = 3.0V, 1.0V < V _{INPUT} < 1.5V			10	Ohm

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Units
I _{CC}	Quiescent Power Supply Current	V _{DD} = Max., V _{IN} = GND or V _{DD}		40	100	µA

Dynamic Electrical Characteristics Over the Operating Range (T_A = -40° to +85°C, V_{DD} = 3.3V +/-10%, GND=0V)

Parameter	Description	Test Conditions	Typ. ⁽²⁾	Units	
X _{TALK}	Crosstalk on High Speed Channels	See Fig. 1 for Measurement Setup	f = 1.35 GHz	-33dB	dB
			f = 100 MHz	-48dB	
O _{IRR}	OFF Isolation on High Speed Channels	See Fig. 2 for Measurement Setup,	f = 1.35 GHz	-33dB	
			f = 100 MHz	-56dB	
I _{LOSS}	Differential Insertion Loss on High Speed Channels	@2.7Gbps (see figure 3)	-1.5	dB	
BW _{_Dx±}	Bandwidth -3dB for Main high speed path (Dx±)	See figure 3	3.25	GHz	
BW _{_AUX/HPD}	-3dB BW for AUX and HPD signals	See figure 3	1.5	GHz	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{DD} = 3.3V, T_A = 25°C ambient and maximum loading.

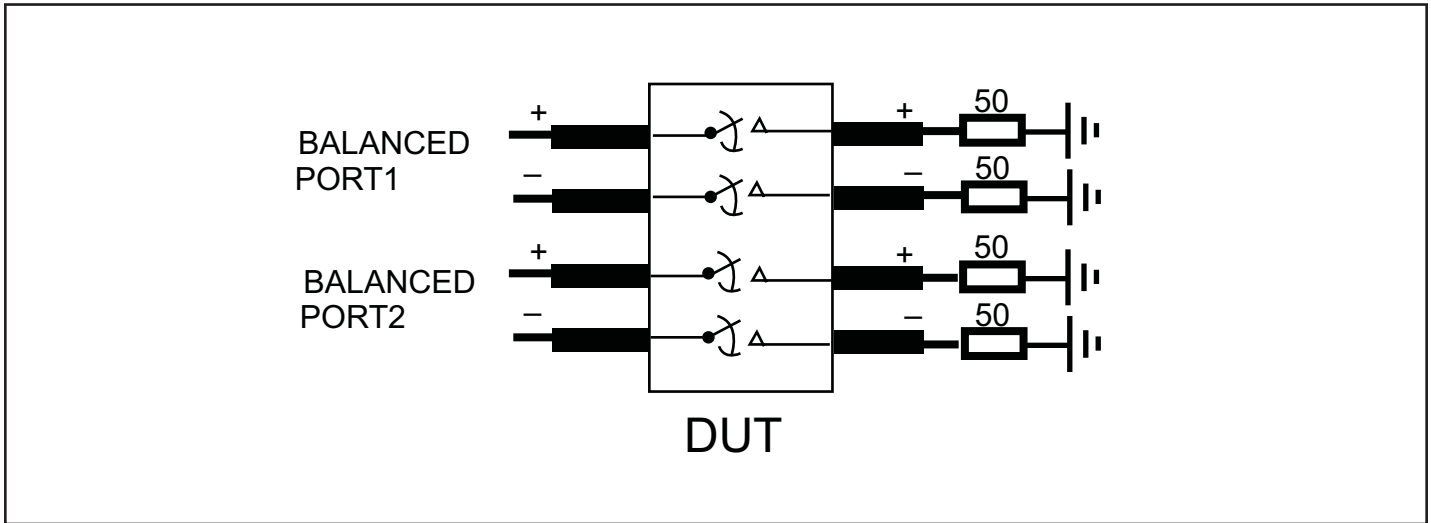


Fig 1. Crosstalk Setup

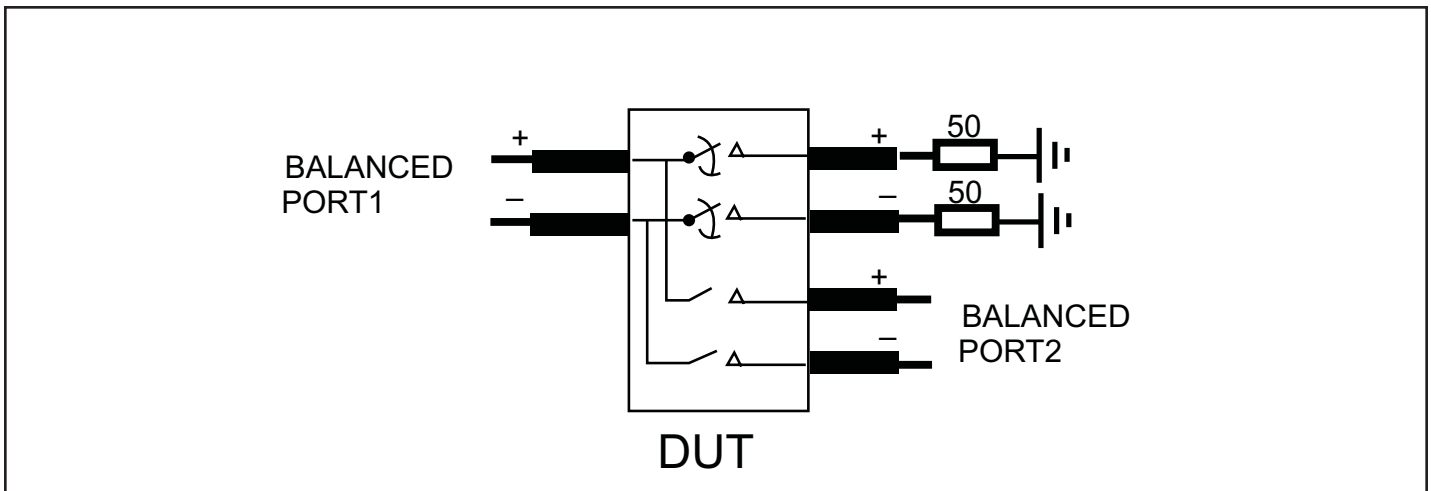


Fig 2. Off-isolation setup

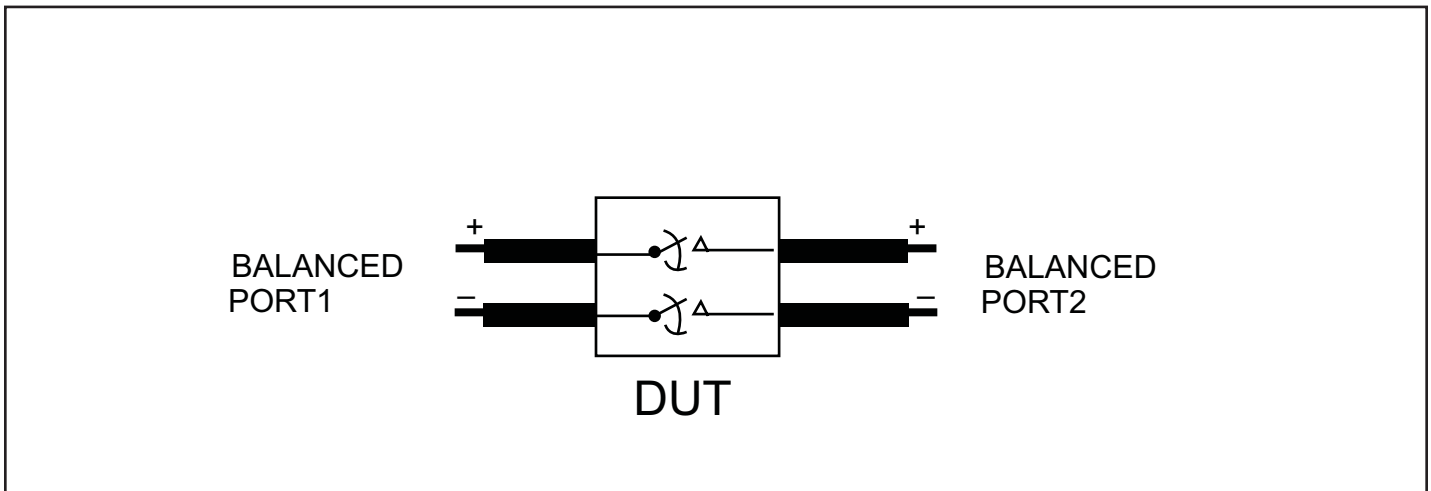


Fig 3. Differential Insertion Loss

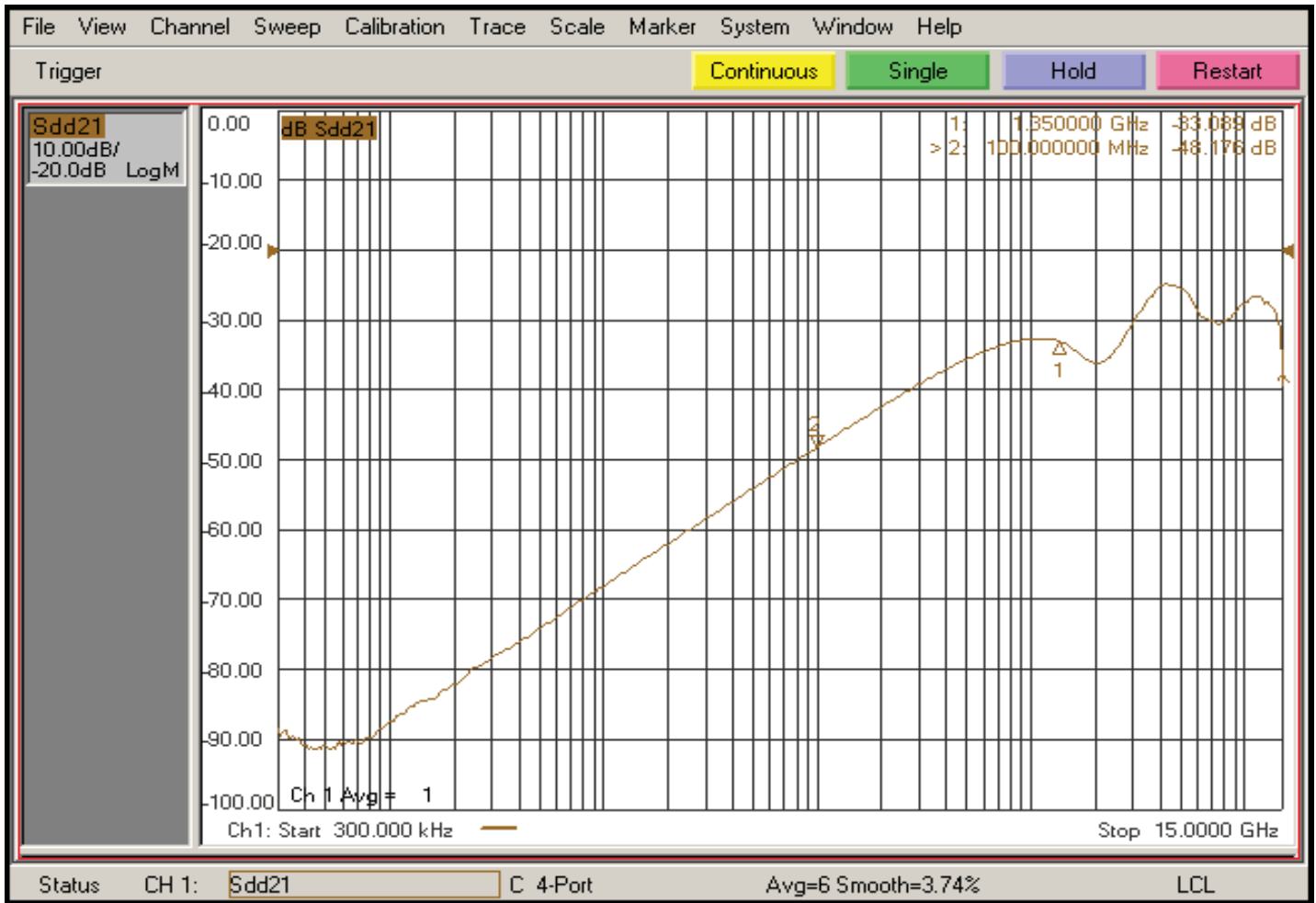


Fig 4. Crosstalk

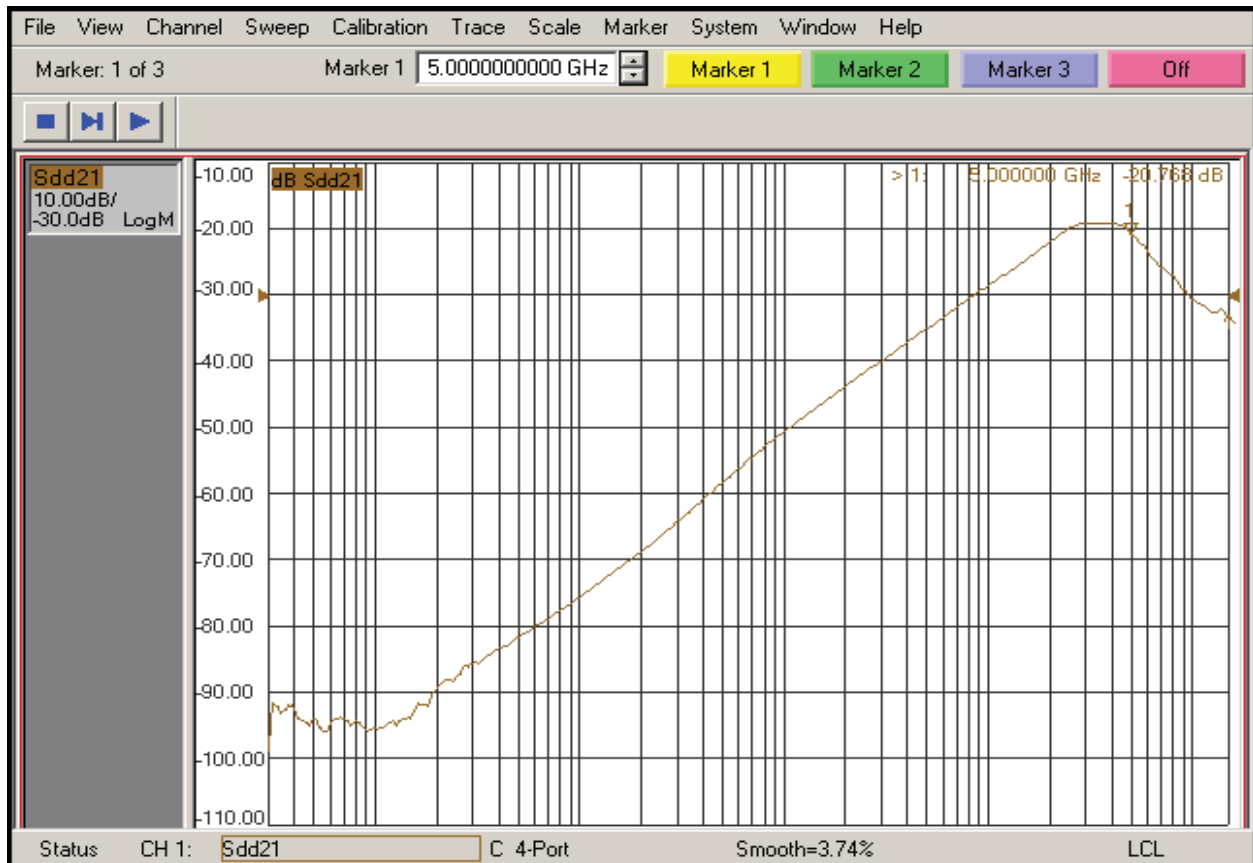


Fig 5. Off Isolation

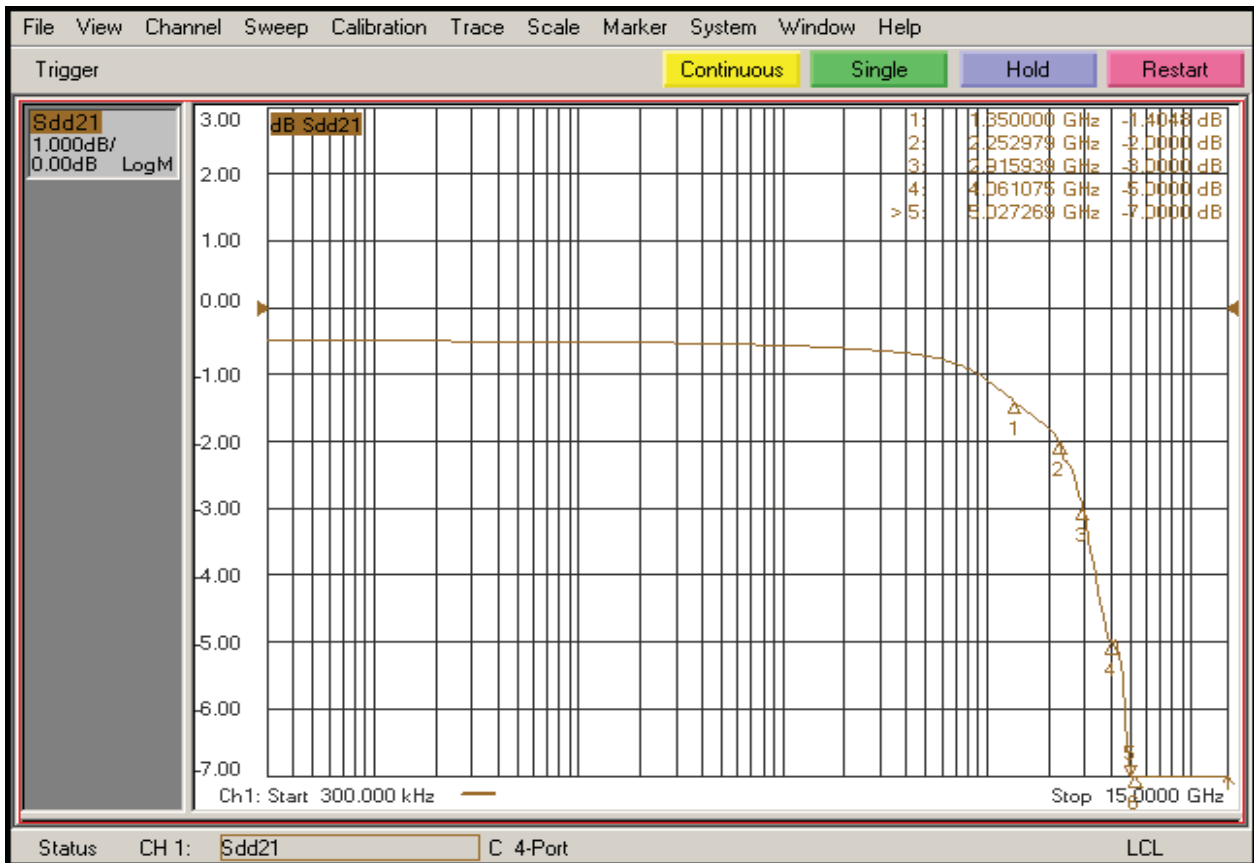


Fig 6. Insertion Loss

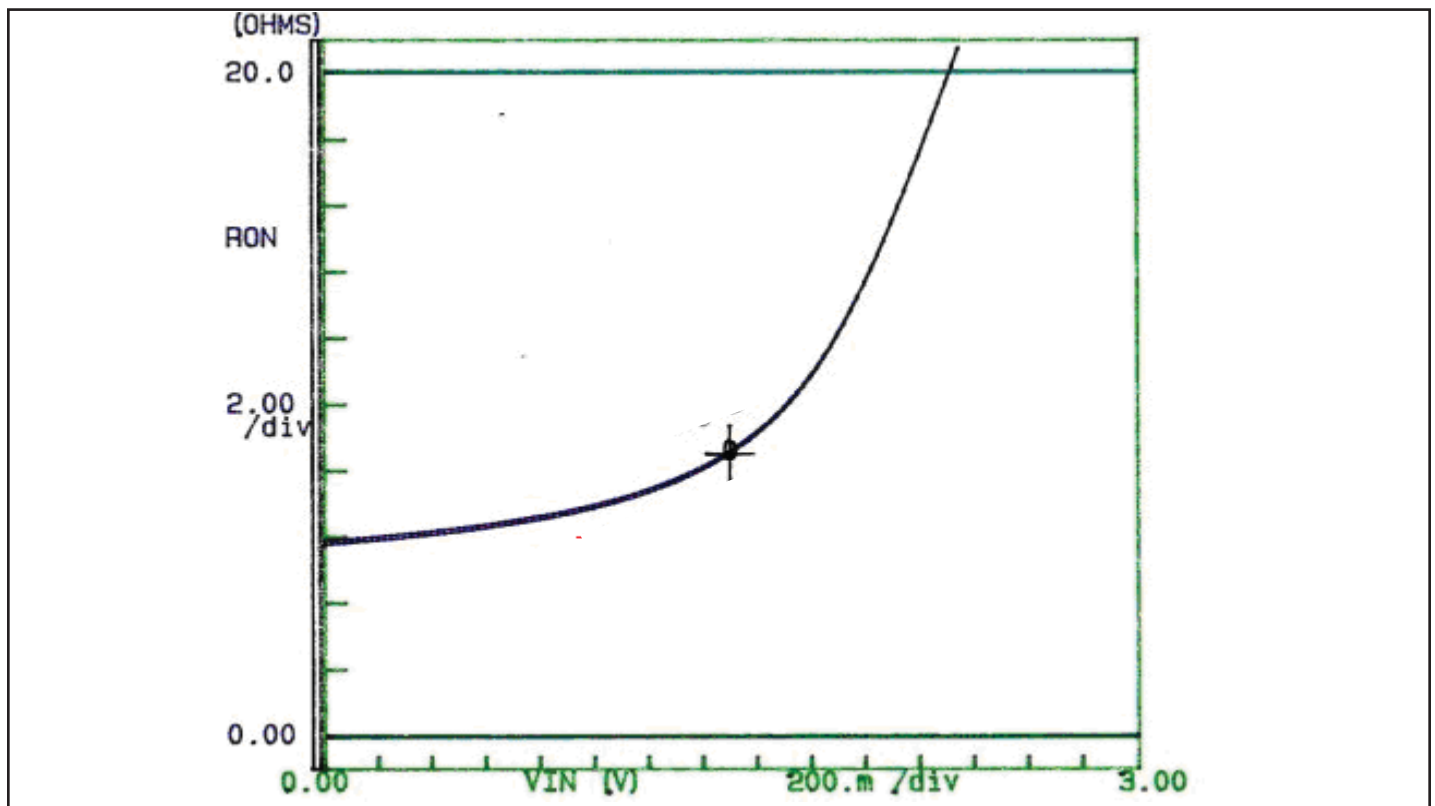
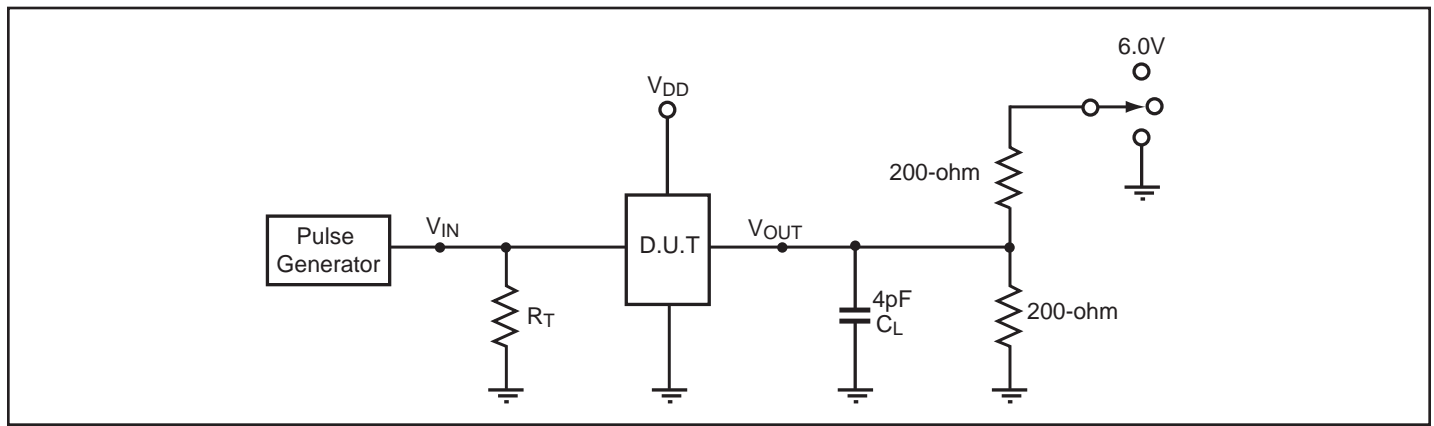


Fig 7. Ron Curve for high speed signal path only (Dx+/-)

Switching Characteristics ($T_A = -40^\circ$ to $+85^\circ\text{C}$, $V_{DD} = 3.3\text{V} \pm 10\%$)

Parameter	Description	Min.	Max.	Units
t_{PZH} , t_{PZL}	Line Enable Time	0.5	15.0	ns
t_{PHZ} , t_{PLZ}	Line Disable Time	0.5	15.0	
T_{pd}	Propagation delay (input pin to output pin)		200	ps
t_{b-b}	Bit-to-bit skew within the same differential pair		7	ps
t_{ch-ch}	Channel-to-channel skew		50	ps

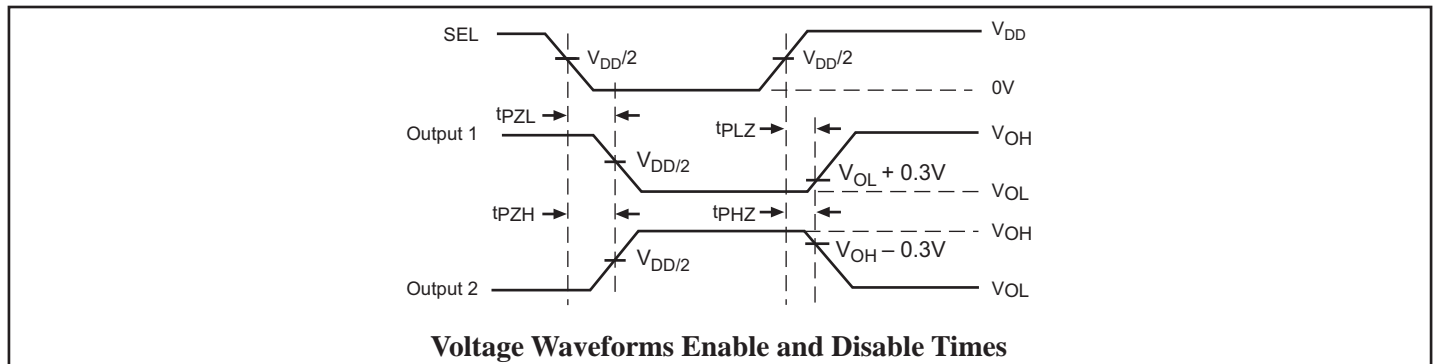
Test Circuit for Electrical Characteristics⁽¹⁻⁵⁾



Notes:

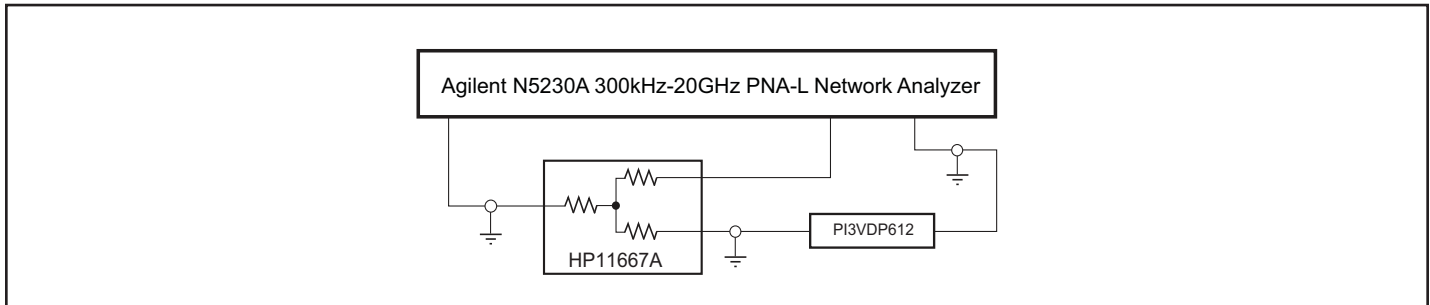
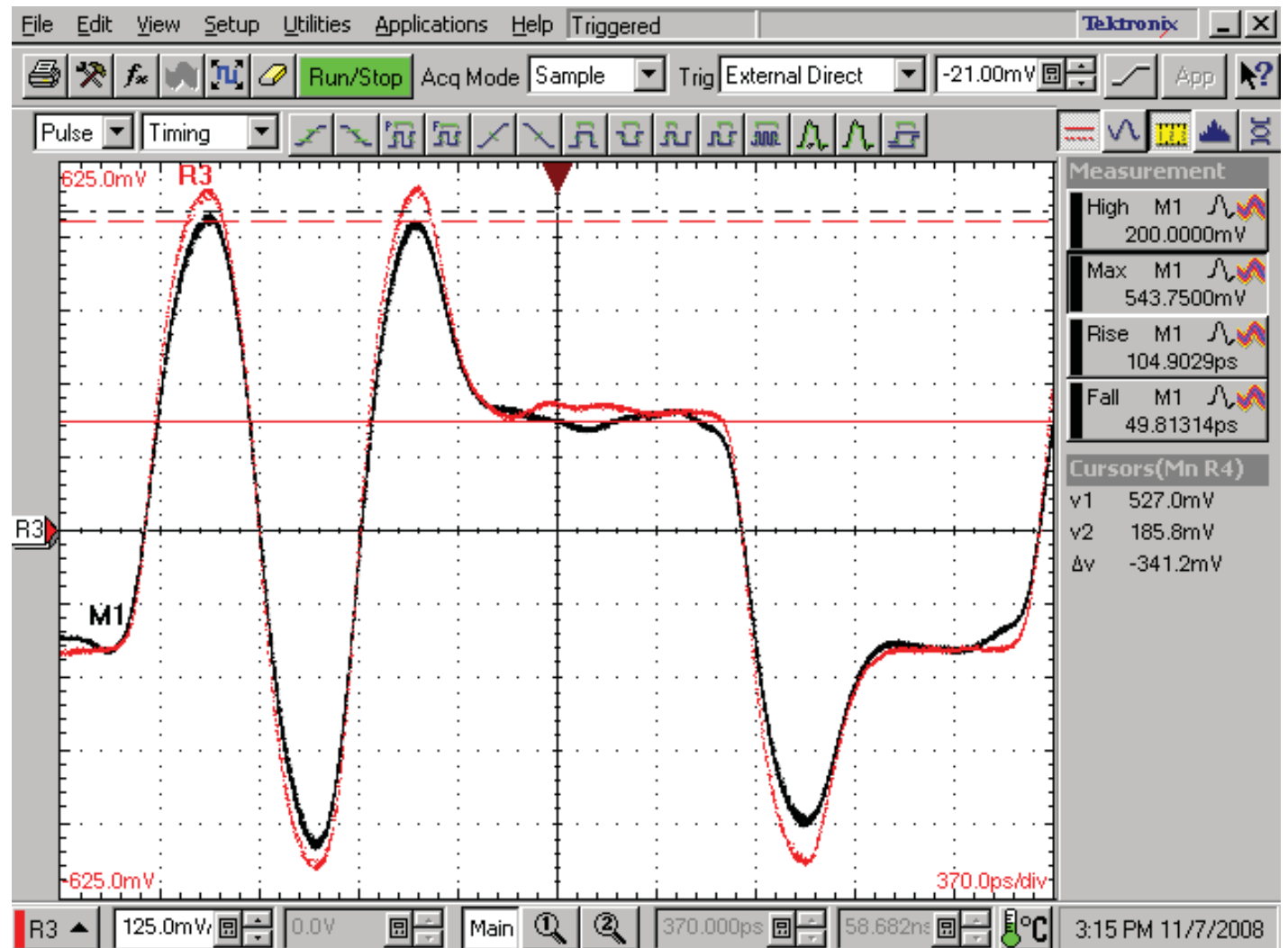
- C_L = Load capacitance: includes jig and probe capacitance.
- R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator
- Output 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 output 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input impulses are supplied by generators having the following characteristics: $PRR \leq \text{MHz}$, $Z_O = 50\Omega$, $t_R \leq 2.5\text{ns}$, $t_F \leq 2.5\text{ns}$.
- The outputs are measured one at a time with one transition per measurement.

Switching Waveforms

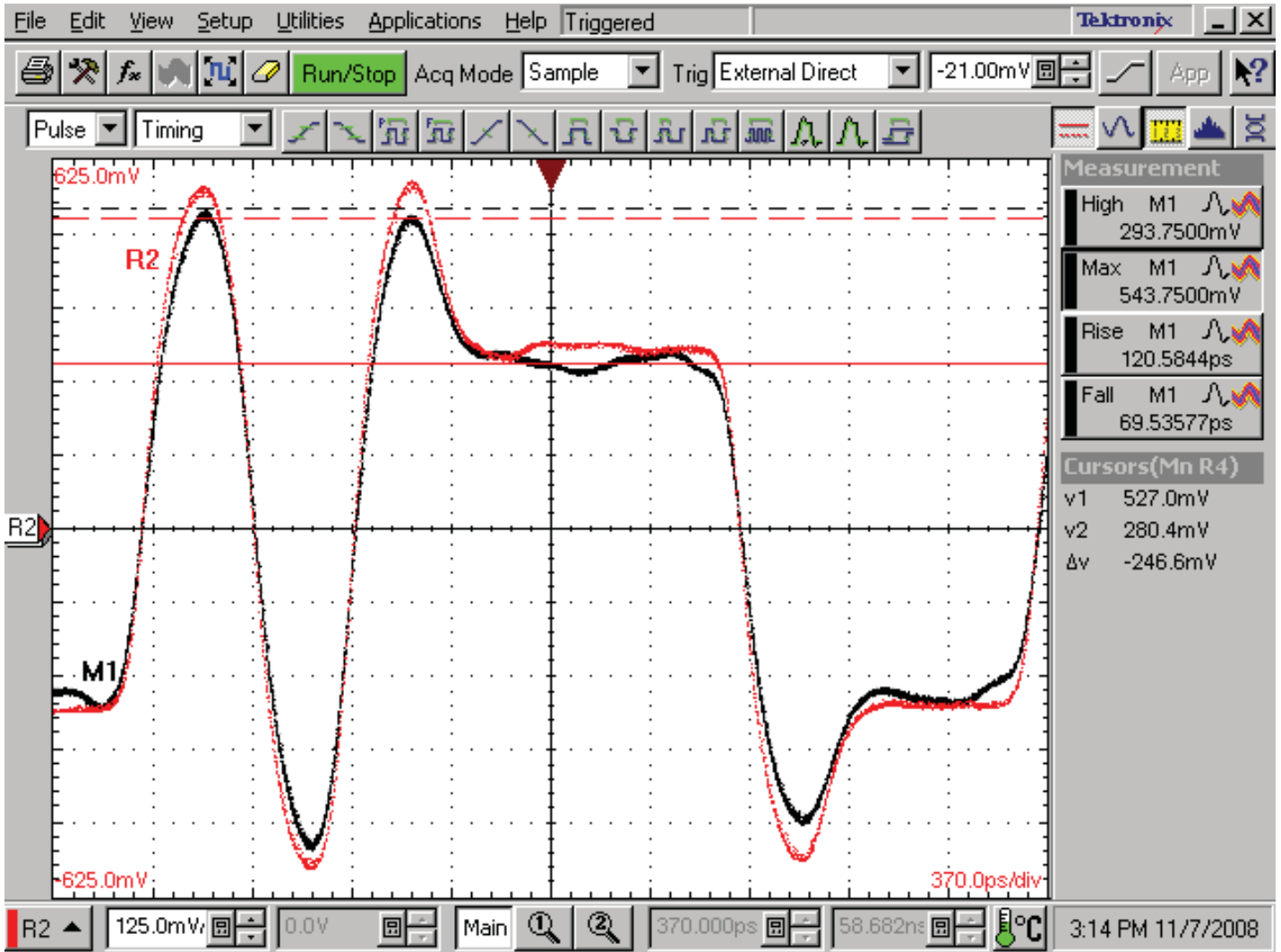


Switch Positions

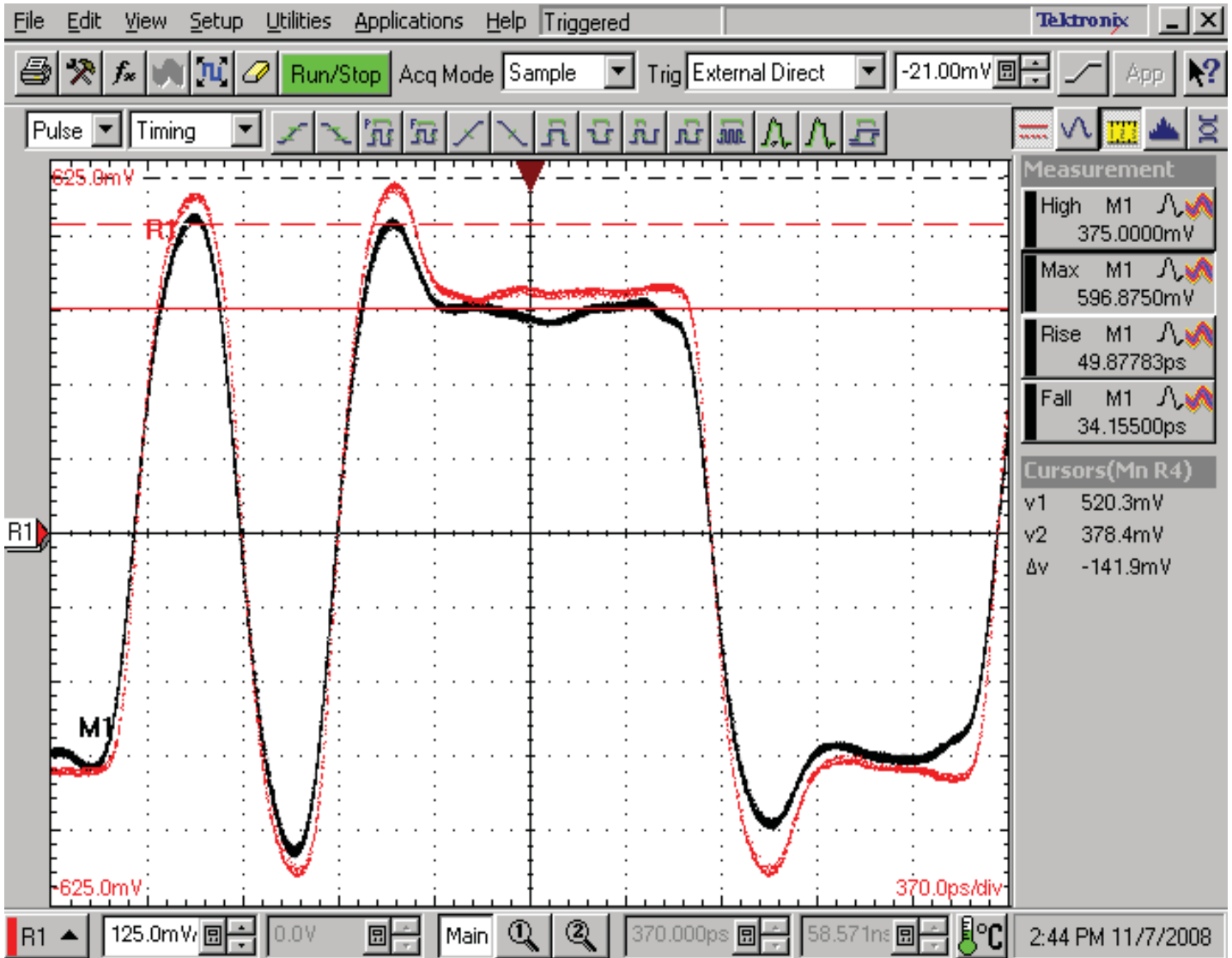
Test	Switch
t_{PLZ} , t_{PZL} (output on B-side)	6.0V
t_{PHZ} , t_{PZH} (output on B-side)	GND
Prop Delay	Open

Test Circuit for Dynamic Electrical Characteristics

Application Section
Pre-emphasis waveforms


Input Pre-emphasis = 9.5dB; Red waveform is input of PI3VDP612 and Black is output of PI3VDP612

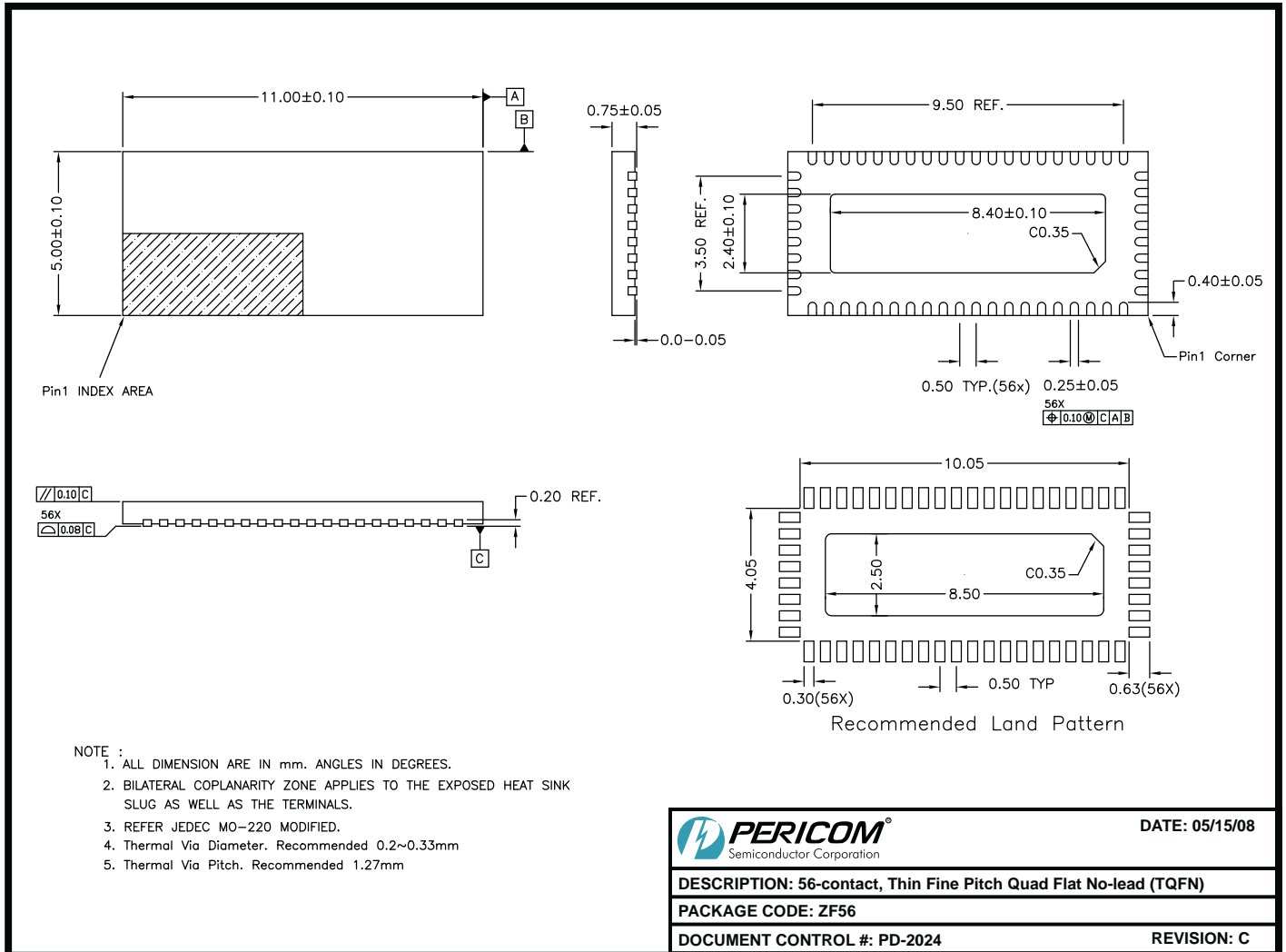


Input Pre-emphasis = 6dB; Red waveform is input of PI3VDP612 and Black is output of PI3VDP612

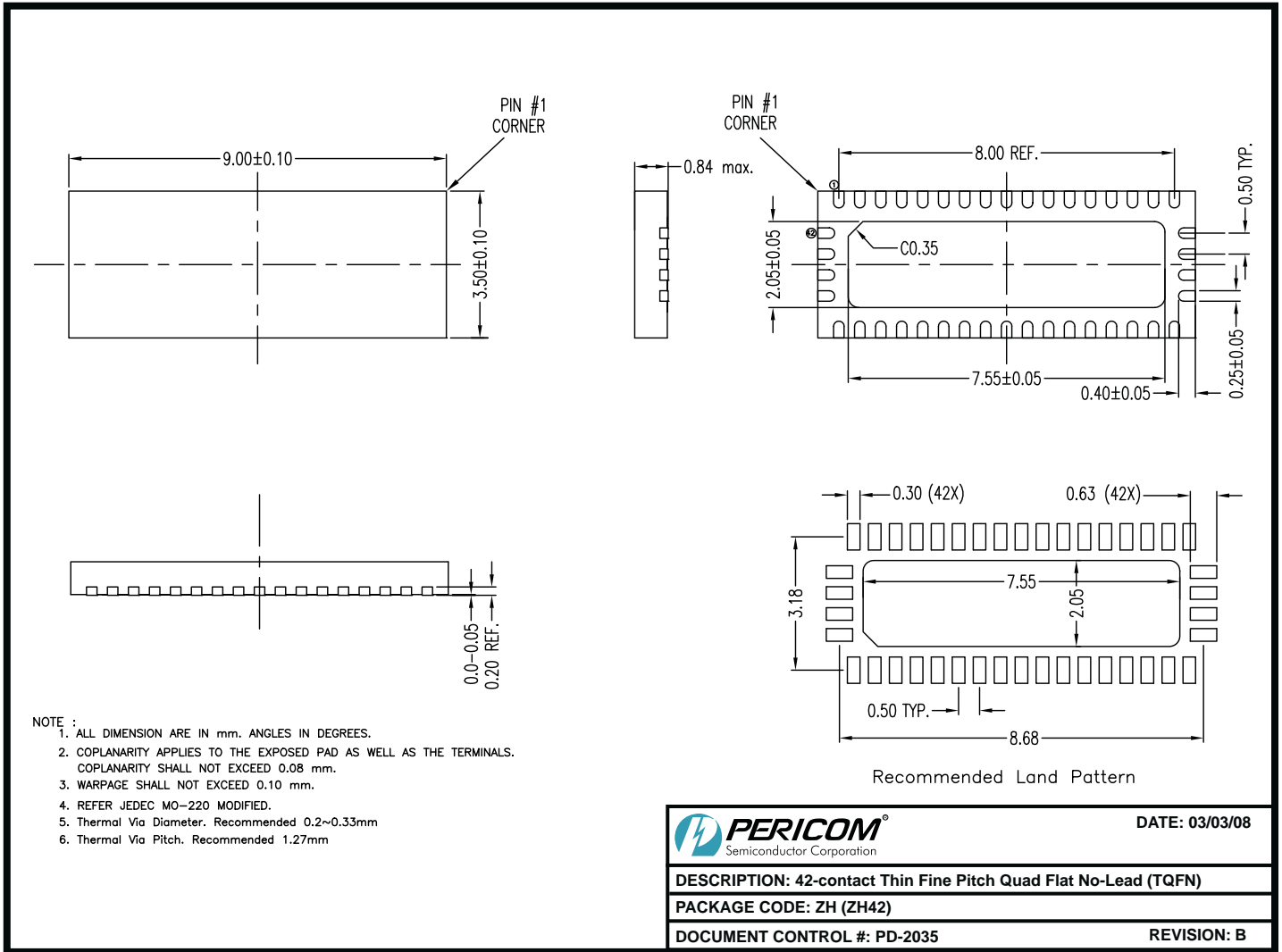


Input Pre-emphasis = 3.5dB; Red waveform is input of PI3VDP612 and Black is output of PI3VDP612

Packaging Mechanical: 56-Contact TQFN (ZF)



Packaging Mechanical: 42-Pin TQFN (ZH)



08-0098

Ordering Information

Ordering Code	Package Code	Package Description
PI3VDP612ZFE	ZF	Pb-free & Green, 56-contact TQFN
PI3VDP612ZHE	ZH	Pb-free & Green, 42-contact TQFN

Notes:

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- "E" denotes Pb-free and Green
- Adding an "X" at the end of the ordering code denotes tape and reel packaging